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ALPHA & OMEGA
SEMICONDUCTOR

AO3424
30V N-Channel MOSFET

General Description

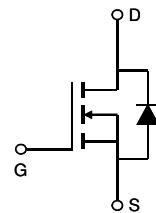
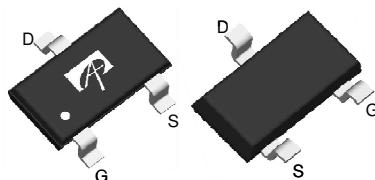
The AO3424 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

Product Summary

V_{DS}	30V
I_D (at $V_{GS}=10V$)	3.8A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 55mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 65mΩ
$R_{DS(ON)}$ (at $V_{GS}=2.5V$)	< 85mΩ



SOT23
Top View Bottom View



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	3.8	A
		3.1	
Pulsed Drain Current ^C	I_{DM}	15	
Power Dissipation ^B	P_D	1.4	W
		0.9	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A $t \leq 10s$	$R_{\theta JA}$	70	90	°C/W
Maximum Junction-to-Ambient ^{A,D} Steady-State		100	125	°C/W
Maximum Junction-to-Lead	$R_{\theta JL}$	63	80	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±12V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} I _D =250μA	0.5	1	1.5	V
I _{D(ON)}	On state drain current	V _{GS} =10V, V _{DS} =5V	15			A
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.8A T _J =125°C		43	55	mΩ
		V _{GS} =4.5V, I _D =3.5A		70	84	
		V _{GS} =2.5V, I _D =1A		47	65	
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =3.8A		59	85	mΩ
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V	0.75	1		V
I _S	Maximum Body-Diode Continuous Current				1.5	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz	185	235	285	pF
C _{oss}	Output Capacitance		25	35	45	pF
C _{rss}	Reverse Transfer Capacitance		10	18	25	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	2.1	4.3	6.5	Ω
SWITCHING PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =3.8A		10	12	nC
Q _g (4.5V)	Total Gate Charge			4.7		nC
Q _{gs}	Gate Source Charge			0.95		nC
Q _{gd}	Gate Drain Charge			1.6		nC
t _{D(on)}	Turn-On Delay Time	V _{GS} =10V, V _{DS} =15V, R _L =3.95Ω, R _{GEN} =3Ω	3.5			ns
t _r	Turn-On Rise Time		1.5			ns
t _{D(off)}	Turn-Off Delay Time		17.5			ns
t _f	Turn-Off Fall Time		2.5			ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =3.8A, dI/dt=100A/μs	8.5	11		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =3.8A, dI/dt=100A/μs	2.6	3.5		nC

A. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25° C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using $\leq 10\text{s}$ junction-to-ambient thermal resistance.

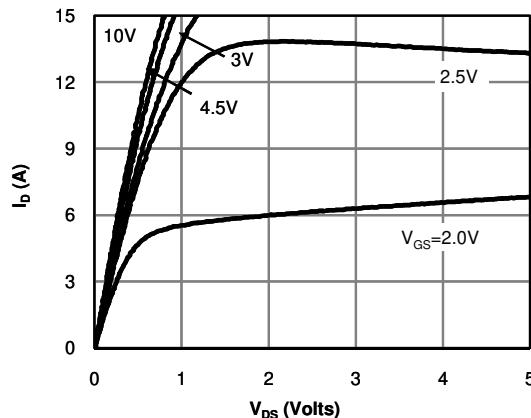
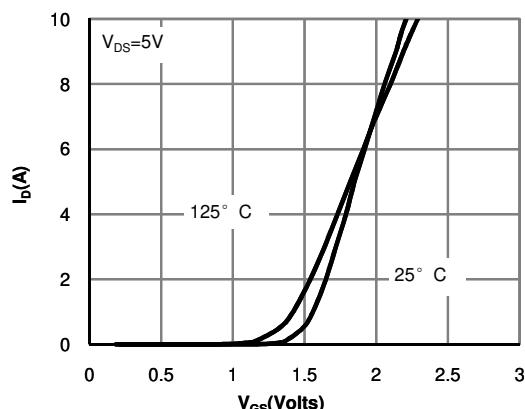
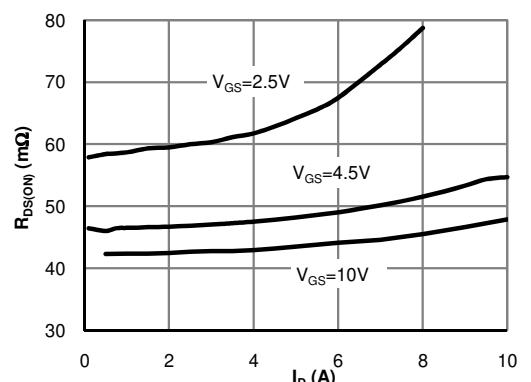
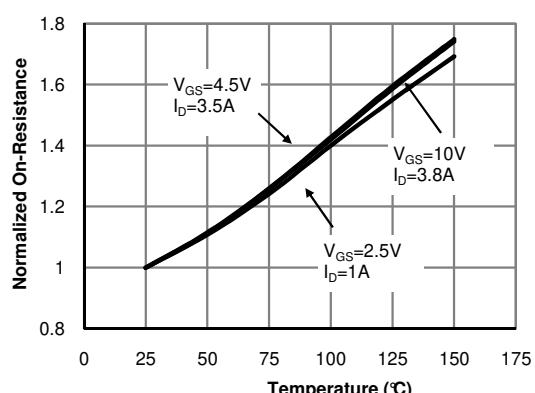
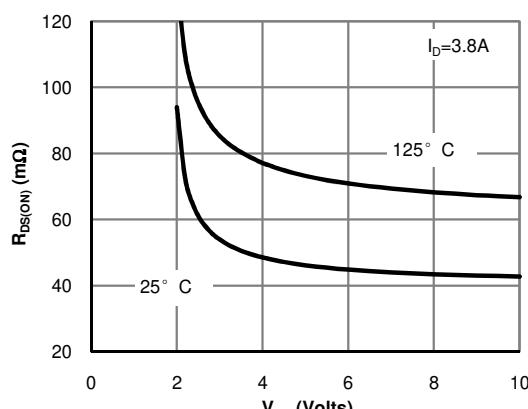
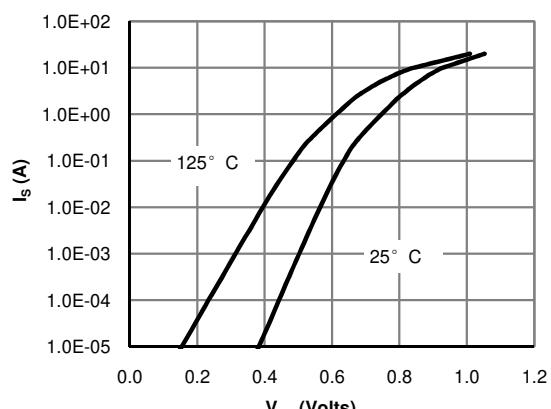
C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initial T_J=25° C.

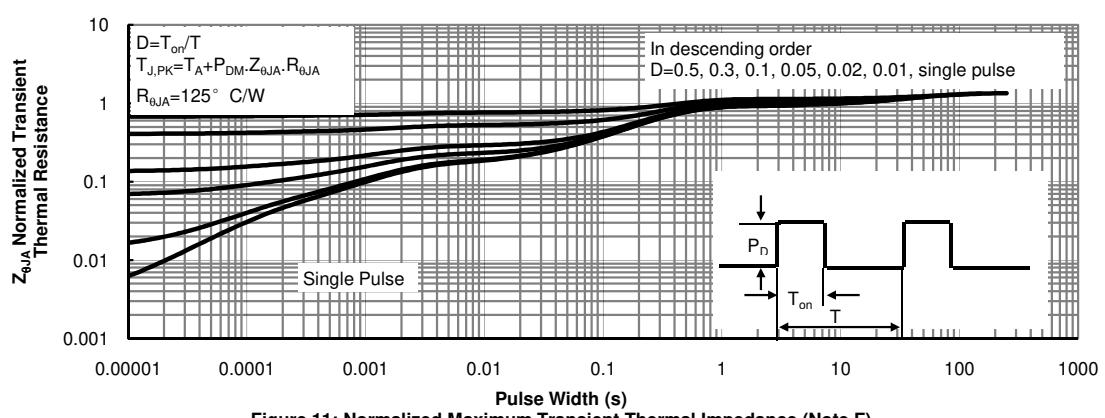
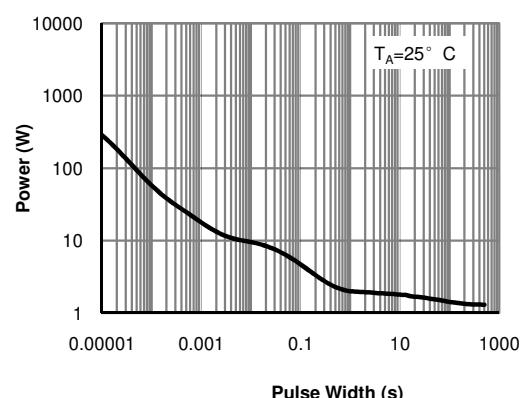
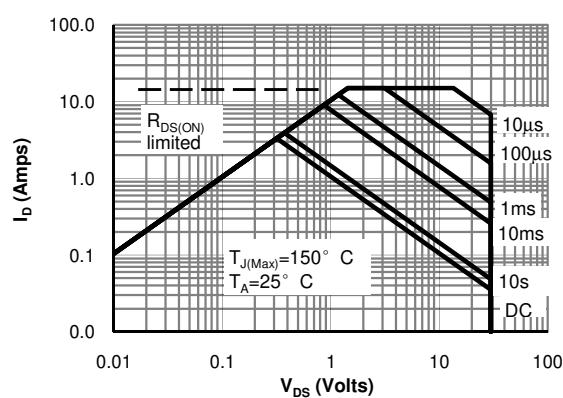
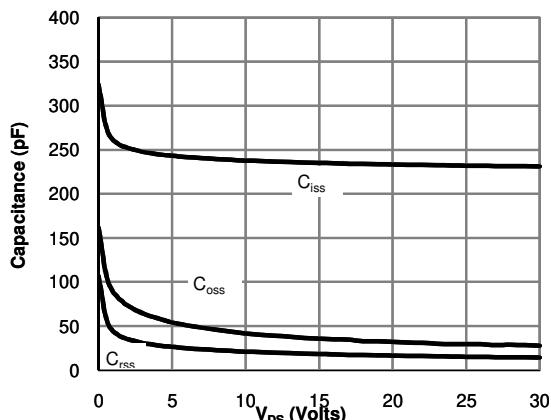
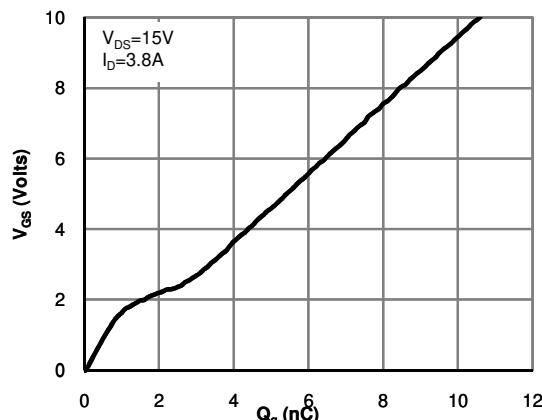
D. The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

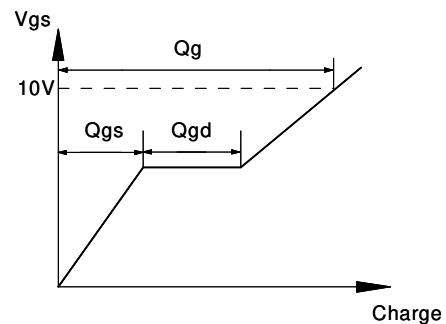
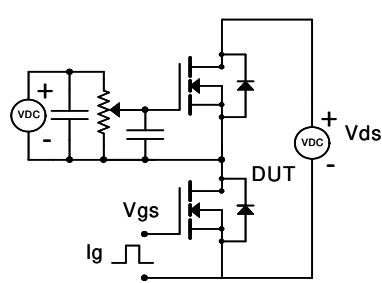
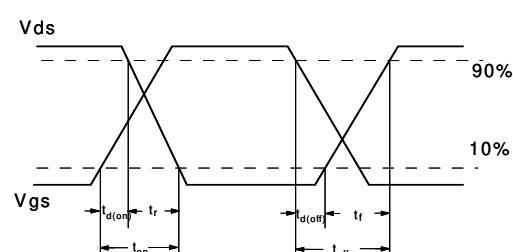
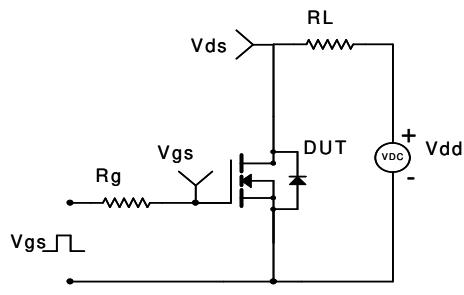
E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms
